

## **MacDermid Inc. and New System, SrL Introduce CircuitJet, an Ink Jet Innerlayer Etch Resist Technology**

February 15, 2007

MacDermid Electronics Solutions is proud to introduce CircuitJet™, an ink jet primary image etch resist for innerlayer manufacture. In partnership with New System, SrL, the technology combines the latest in innovative ink jet equipment design with a high resolution UV-curable etch resist ink. CircuitJet™ is a unique, patent-pending process that delivers the capability to produce the highest technology innerlayer circuit patterns with direct ink jet printing. This process produces layers “ready for etch” with reduced cycle time, while eliminating the need for all artwork, phototools, lamination, exposure and developing.

MacDermid and New System will display and demonstrate the CircuitJet™ ink jet equipment, in combination with its CircuitJet™ 100 UV-curable ink jet resist, at the IPC Printed Circuit Expo in Los Angeles, California during the week of February 19<sup>th</sup>, 2007. See the equipment and demonstration at MacDermid’s booth 501 and New System’s booth 745.

MacDermid Electronics Solutions is a global specialty chemical and materials supplier serving the printed circuit board, semi-conductor packaging, lead frame, RFID, and flexible circuitry markets. MacDermid Inc. has numerous R&D, manufacturing, sales, and technical support facilities worldwide. Visit MacDermid Electronics Solutions at [www.macdermid.com/electronics](http://www.macdermid.com/electronics)

For more information on CircuitJet™ please contact Lisa Guerrero at +1 (203) 575-5743.